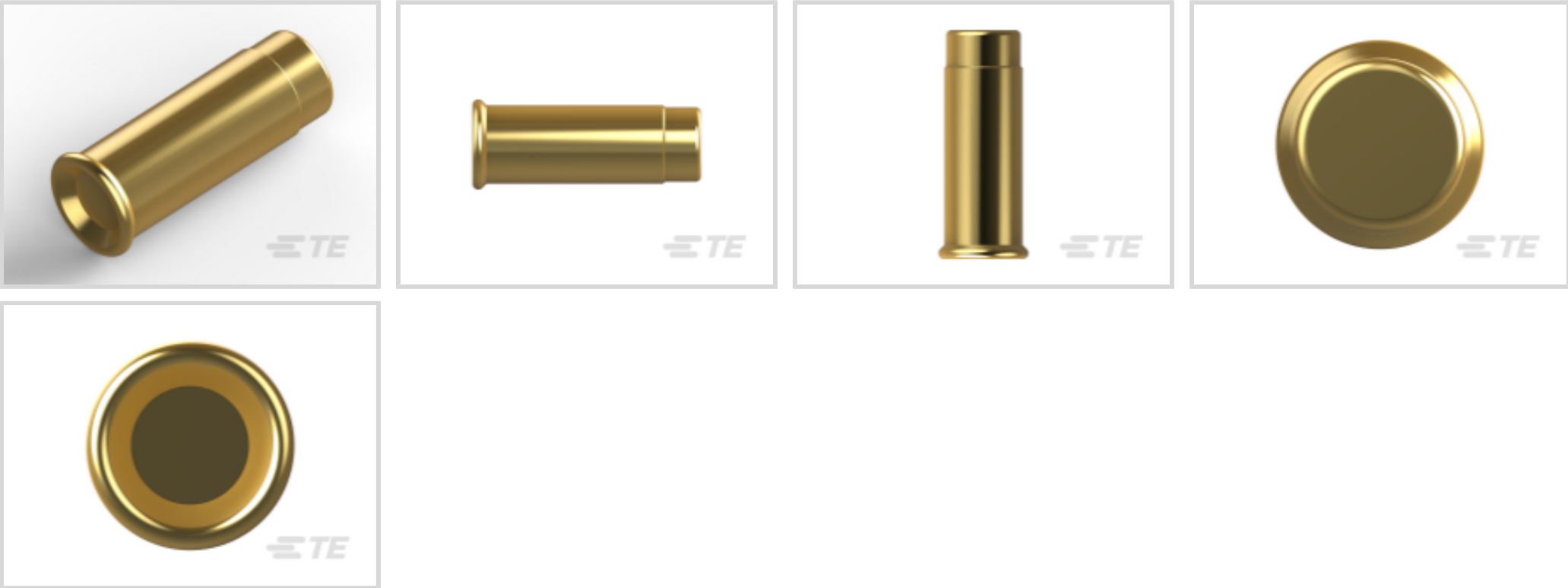




TE Internal #: 1-50871-8
Pin Sockets, Socket Length 7.32 mm [.288 in], PCB Hole Diameter .101 in [2.56 mm], Open Bottom, 1.31 - 2.08 mm² Wire Size, 16 - 14 AWG Wire Size
[View on TE.com >](#)

Connectors > Socket Connectors > Pin Sockets > Miniature Spring Sockets: Open Bottom, Beryllium Copper, 7.5A



Socket Length: 7.32 mm [.288 in]
PCB Hole Diameter: 2.56 mm [.101 in]
Socket Sleeve Style: Open Bottom
Wire Size: 1.31 - 2.08 mm²

[All Miniature Spring Sockets: Open Bottom, Beryllium Copper, 7.5A \(9\)](#)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Socket Sleeve Style	Open Bottom
Connector System	Cable-to-Board
Sealable	No

Configuration Features

Compatible With Wire & Cable Type	Discrete Wire
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Body Features

Sleeve Material	Copper
Sleeve Plating Material	Gold Flash over Nickel

Contact Features

Contact Spring Plating Material	Gold
Contact Spring Plating Thickness	.762 µm[30 µin]
Contact Mating Area Plating Material Thickness	30 µm[30 µin]
Contact Base Material	Beryllium Copper



Contact Current Rating (Max)	7.5 A
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Termination Features

Insertion Method	Hand/Semi-Automatic
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Termination Method to Wire & Cable	Solder

Dimensions

PCB Thickness (Recommended)	.79 - 3.18 mm[.031 - .125 in]
Socket Length	7.32 mm[.288 in]
PCB Hole Diameter	2.56 mm[.101 in]
Wire Size	1.31 - 2.08 mm²
Mating Pin Diameter Range	1.42 - 1.65 mm[.056 - .065 in]

Usage Conditions

Operating Temperature Range	-65 - 125 °C[-85 - 257 °F]
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Operation/Application

Solder Process Feature	None
Circuit Application	Power & Signal

Packaging Features

Packaging Quantity	2000
Packaging Method	Bag, Loose Piece

Other

Spring Material	Beryllium Copper
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Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC



Free

Solder Process Capability

Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # 1-50871-3

SOCKET,MIN-SPR AU SER-5

Customers Also Bought

TE Part # 2294417-1

INDUSTRIAL MINI I/O HDR TYPE I
EMBOSS

TE Part # 3-1734577-4

MOD-JK,8P8C,SHD W/O LED, 50u"

TE Part # 6-104652-0

100 50/50 GRID DRST SFMNT RCPT

TE Part # 1909782-1

BOARD TO WIRE WAFER 1.2MM TOP
ENTRY

TE Part # 1546073-3

3 POS 5.08MM TERMI-BLOK

TE Part # 1-1625890-5

2W SM M/OX 5% 15R

TE Part # 451555J001

V4-2.0-0-SP-SM

TE Part # 7-1415537-1

Force Guided Relay with 6 contacts



Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-50871-8_W.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-50871-8_W.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-50871-8_W.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Application Specification

English